

# Data and signal line chokes

Common-mode chokes, ring core 0.011 ... 2.2 mH, 100 ... 200 mA, 60 °C

Series/Type: B82793C2
Date: April 2008

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EPCOS								
Data and signal line chokes	В	827	930	22				
Common-mode chokes, ring core								
SMD								
Rated voltage 42 V AC/80 V DC Rated inductance 0.011 mH to 2.2 mH Rated current 100 mA to 200 mA				- 50 293798- - 5303 - 14 7363				
Construction								
<ul> <li>Current-compensated ring core quad choke</li> <li>Ferrite core</li> <li>LCP case (UL 94 V-0)</li> <li>Silicone potting</li> <li>Bifilar winding</li> </ul>								
Features								
<ul><li>Suitable for reflow soldering</li><li>RoHS-compatible</li></ul>								
Function								

Suppression of asymmetrical interference coupled in on lines, whereas data signals up to some MHz can pass unaffectedly

# Applications

- Telecom applications
- ISDN systems

# **Terminals**

- Base material CuSn6
- Layer composition Ni, Sn
- Hot-dipped

# Marking

- Marking on component: Manufacturer, ordering code date of manufacture (YMMD)
- Minimum data on reel: Manufacturer, ordering code, L value and tolerance, quantity, date of packing

# Delivery mode and packing unit

- 16-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 1000 pcs./reel







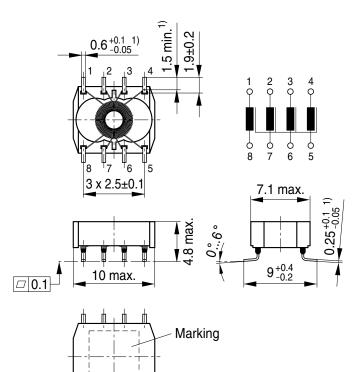
#### B82793C2

# Data and signal line chokes

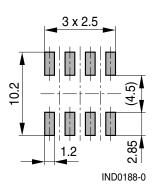
### Common-mode chokes, ring core

<u>SMD</u>

#### Dimensional drawing and pin configuration



#### Layout recommendation



1) Soldering area

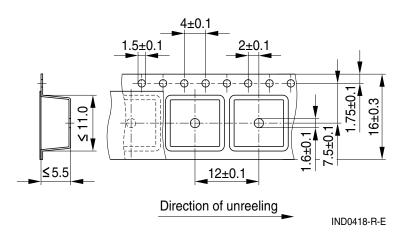
IND0187-L-E

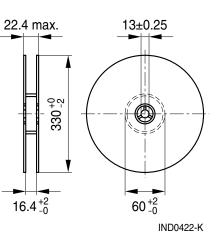
Dimensions in mm

Reel

#### **Taping and packing**

Blister tape





Dimensions in mm

Please read *Cautions and warnings* and *Important notes* at the end of this document.





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#### Technical data and measuring conditions

Rated voltage V <sub>R</sub>	42 V AC (50/60 Hz) / 80 V DC
Rated temperature T <sub>R</sub>	60 °C
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature
Rated inductance L <sub>R</sub>	$\begin{array}{l} \mbox{Measured with Agilent 4284A at 0.1 mA, 20 °C} \\ \mbox{Measuring frequency: } L_R \leq 1 \mbox{ mH} = 100 \mbox{ kHz} \\  L_R > 1 \mbox{ mH} = 10 \mbox{ kHz} \\ \mbox{Inductance is specified per winding.} \end{array}$
Inductance tolerance	–30/+50% at 20 °C
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with I <sub>R</sub> , 20 °C
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4284A at 5 mA, 20 °C, typical values Measuring frequency: $L_R \le 11 \ \mu H = 1 \ MHz$ $L_R > 11 \ \mu H = 100 \ kHz$
DC resistance R <sub>typ</sub>	Measured at 20 °C, typical values, specified per winding
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: (245 $\pm$ 5) °C, (3 $\pm$ 0.3) s Wetting of soldering area $\geq$ 95% (to IEC 60068-2-58)
Resistance to soldering heat	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-58)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions (packaged)	–25 °C … +40 °C, ≤75% RH
Weight	Approx. 0.4 g
Weight	

## Characteristics and ordering codes

L <sub>R</sub>	L <sub>stray,typ</sub>	I <sub>R</sub>	R <sub>typ</sub>	V <sub>test</sub>	Ordering code
mH	nH	mA	mΩ	VDC, 2 s	
0.011	120	200	60	750	B82793C2113N201
0.047	170	150	150	750	B82793C2473N201
0.47	170	100	350	750	B82793C2474N215
2.2	220	100	400	750	B82793C2225N265

B82793C2

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IND0876-L

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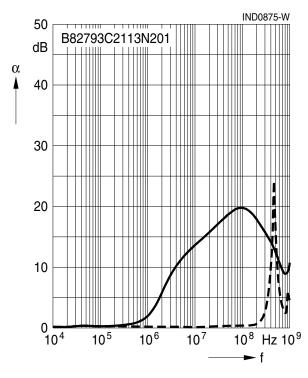
SMD

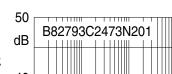
**Insertion loss**  $\alpha$  (typical values at  $|Z| = 50 \Omega$ , 20 °C)

asymmetrical, all branches in parallel (common mode)

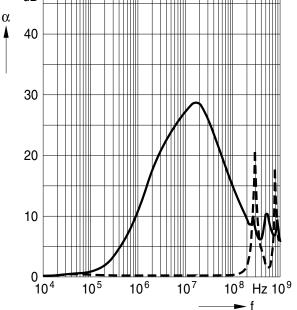
---- symmetrical (differential mode)

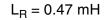
 $L_{R} = 0.011 \text{ mH}$ 

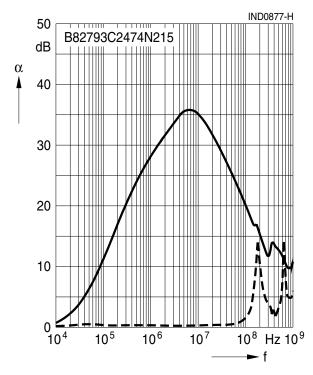




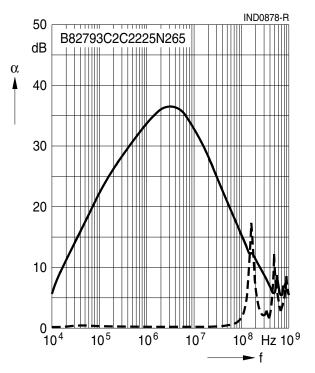
 $L_{\rm R} = 0.047 \text{ mH}$ 







 $L_{R} = 2.2 \text{ mH}$ 



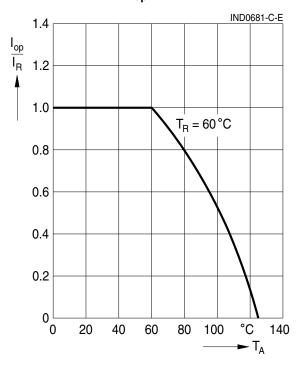


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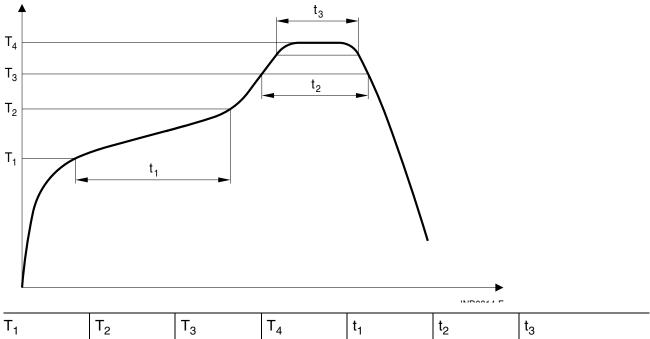
<u>SMD</u>

#### Current derating $I_{op}/I_R$ versus ambient temperature



#### Recommended reflow soldering curve

Pb-free solder material (based on JEDEC J-STD 020C)



•n	°C	°C	°C	s	52 S	s
150	200	217	250	< 110	< 90	
						·

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Time from 25 °C to  $T_4$ : max 300 s Maximal numbers of reflow cycles: 3

Please read *Cautions and warnings* and *Important notes* at the end of this document.

04/08





#### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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